IN THE CLAIMS

3

Please replace all prior versions, and listings, of claims in the application with the following list of claims. Additions are indicated by underlining and deletions are indicated by strikeouts and/or double bracketing.

1-125. (Cancelled)

wire.

- 126. (Previously presented) A method, comprising:
 - providing a semiconductor nanoscale wire;
 - patterning a mask on the nanoscale wire to define at least a first portion not covered by the mask and a second portion covered by the mask;
 - exposing the first portion but not the second portion to a bulk metal; and diffusing at least a portion of the bulk metal into the first portion of the nanoscale
- 127. (Previously presented) The method of claim 126, wherein the semiconductor nanoscale wire comprises silicon.
- 128. (Previously presented) The method of claim 127, comprising diffusing at least a portion of the bulk metal into the first portion of the nanoscale wire to form a metal silicide having a stoichiometric ratio of silicon and at least one metal.
- 129. (Previously presented) The method of claim 128, wherein the metal silicide comprises nickel silicide.
- (Previously presented) The method of claim 126, wherein the bulk metal comprises a transition metal.
- 131. (Previously presented) The method of claim 126, wherein the bulk metal comprises nickel.

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132. (Previously presented) The method of claim 126, wherein the first portion of the nanoscale wire has a smallest dimension less than 200 nm.

4

- 133. (Previously presented) The method of claim 126, wherein the nanoscale wire is a single crystal.
- 134. (Previously presented) The method of claim 126, wherein the mask comprises photoresist.
- 135-136. (Cancelled)
- 137. (Previously presented) The method of claim 126, wherein the nanoscale wire is a nanowire.
- 138. (Previously presented) The method of claim 126, comprising diffusing at least a portion of the bulk metal into the first portion of the nanoscale wire such that the first region has a resistivity of less than about 60 microOhm cm.
- 139. (Previously presented) The method of claim 126, comprising diffusing at least a portion of the bulk metal into the first portion of the nanoscale wire such that the first region is able to carry a current density of at least about 10⁸ A/cm².
- 140. (Currently amended) A method, comprising:
 - promoting a method comprising an act of diffusing at least a portion of a bulk metal into at least a portion of a semiconductor nanoscale wire, the bulk metal and the semiconductor nanoscale wire being adjacent, wherein the semiconductor nanoscale wire comprises at least one portion having a smallest dimension of less than about 500 nm.
- 141. (Previously presented) The method of claim 140, wherein the bulk metal comprises nickel.

 (Previously presented) The method of claim 140, wherein the semiconductor nanoscale wire comprises silicon.

5

- 143. (Currently amended) The method of claim 140, comprising promoting a method comprising an act of diffusing at least a portion of the bulk metal into at least a portion of the semiconductor wire to form a metal silicide.
- 144. (Previously presented) The method of claim 143, wherein the metal silicide has a stoichiometric ratio of silicon and at least one metal.
- 145. (Previously presented) The method of claim 144, wherein the metal silicide comprises nickel silicide.